

February 2008

74VCX38 Low Voltage Quad 2-Input NAND Gate with Open Drain Outputs and 3.6V Tolerant Inputs and Outputs

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD}:
- 2.8ns max. for 3.0V to 3.6V V_{CC}
- Power-Off high impedance inputs and outputs
- Static Drive (I_{OL}):
 - +24mA @ 3.0V V_{CC}
- Uses patented Quiet Series[™] noise/EMI reduction circuitry
- Latchup performance exceeds JEDEC 78 conditions
- ESD performance:
 - Human body model > 2000V
- Machine model > 250V
- Leadless DQFN package

Ordering Information

General Description

The VCX38 contains four 2-input NAND gates with open drain outputs. This product is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V.

The VCX38 is fabricated with advanced CMOS technology to achieve high-speed operation while maintaining CMOS low power dissipation.

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Order Number	Package Number	Package Description
74VCX38M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX38BQX ⁽¹⁾	MLP14A	14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX38MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Note:

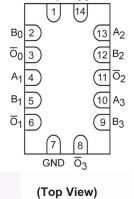
1. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

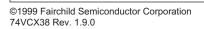


Connection Diagrams Pin Assignments for SOIC and TSSOP 14 $V_{\rm CC}$ A_0 13 Α2 B₀ \overline{o}_0 12 B₂ 11 02 Α₁ 10 A_3 B₁ 9 $\overline{0}_1$ B₃ 8 $\overline{0}_3$ GND Pad Assignments for DQFN A₀ V_{CC} 1 14 B₀ (13 A2 2



Pin Description

Pin Names	Description		
A _n , B _n	Inputs		
Ōn	Outputs		



Logic Symbol

A₀

B₀

 A_1

В₁

 A_2

B₂

 A_3

B₃

IEEE/IEC

&

 $\overline{0}_0$

• 0₁

• 0₂

 $\overline{0}_3$

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V _{CC}	Supply Voltage	-0.5V to +4.6V
VI	DC Input Voltage	-0.5V to 4.6V
Vo	Output Voltage ⁽²⁾	-0.5V to 4.6V
I _{IK}	DC Input Diode Current, V _I < 0V	–50mA
I _{ОК}	DC Output Diode Current, V _O < 0V	–50mA
I _{OL}	DC Output Source/Sink Current	+50mA
I _{CC} or GND	Supply Pin	±100mA
T _{STG}	Storage Temperature Range	–65°C to +150°C

Note:

2. I_O Absolute Maximum Rating must be observed.

Recommended Operating Conditions⁽³⁾

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
V _{CC}	Power Supply Operating	1.2V to 3.6V
VI	Input Voltage	-0.3V to 3.6V
Vo	Output Voltage	0V to V _{CC}
I _{OL}	Output Current	
	V _{CC} = 3.0V to 3.6V	±24mA
	$V_{CC} = 2.3V \text{ to } 2.7V$	±18mA
	$V_{CC} = 1.65V \text{ to } 2.3V$	±6mA
	$V_{CC} = 1.4V$ to 1.6V	±2mA
	$V_{CC} = 1.2V$	± 100µA
T _A	Free Air Operating Temperature	-40°C to +85°C
$\Delta t / \Delta V$	Minimum Input Edge Rate, $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10ns/V

Note:

3. Floating or unused inputs must be held HIGH or LOW

Symbol	Parameter	V _{CC} (V)	Conditions	Min	Max	Units
V _{IH}	HIGH Level Input Voltage	2.7–3.6		2.0		V
		2.3–2.7	-	1.6		
		1.65–2.3	-	$0.65 \times V_{CC}$		1
		1.4–1.6		$0.65 \times V_{CC}$		1
		1.2		$0.65 \times V_{CC}$		
V _{IL}	LOW Level Input Voltage	2.7–3.6			0.8	V
		2.3–2.7			0.7	
		1.65–2.3			$0.35 imes V_{CC}$	
		1.4–1.6			$0.35 imes V_{CC}$	
		1.2			$0.05 \times V_{CC}$	
V _{OL}	LOW Level Output Voltage	2.7–3.6	I _{OL} = 100μA		0.2	V
		2.7	$I_{OL} = 12 \text{mA}$		0.4	1
		3.0	I _{OL} = 18mA		0.4	1
		3.0	$I_{OL} = 24 \text{mA}$		0.55	1
		2.3–2.7	I _{OL} = 100μA		0.2	1
		2.3	$I_{OL} = 12 \text{mA}$		0.4	
		2.3	I _{OL} = 18mA		0.6	
		1.65–2.3	$I_{OL} = 100 \mu A$		0.2	
		1.65	$I_{OL} = 6mA$		0.3	
		1.4–1.6	$I_{OL} = 100 \mu A$		0.2	
		1.4	$I_{OL} = 2mA$		0.35	
		1.2	$I_{OL} = 100 \mu A$		0.05	
I _I	Input Leakage Current	1.2–3.6	$0 \le V_I \le 3.6V$		±5.0	μA
I _{OFF}	Power-Off Leakage Current	0	$0 \leq (V_I, V_O) \leq 3.6V$		10.0	μA
I _{CC}	Quiescent Supply Current	1.2–3.6	$V_I = V_{CC}$ or GND		20.0	μA
			$V_{CC} \le (V_I) \le 3.6V$		±20.0	
ΔI_{CC}	Increase in I _{CC} per Input	2.7–3.6	$V_{IH} = V_{CC} - 0.6V$		750	μA
I _{OHZ}	Off State Current	1.2–3.6	V _O = 3.6		10.0	μA

				T _A = −40°C to +85°C			Figure
Symbol	Parameter	V _{CC} (V)	Conditions	Min.	Max.	Units	Number
t _{PZL} , t _{PZH}	Propagation Delay	3.3 ± 0.3	$C_L = 30 pF, R_L = 500 \Omega$	0.6	2.8	ns	Fig. 1
		2.5 ± 0.2		0.8	3.7		Fig. 2
		1.8 ± 0.15		1.0	6.7		
		1.5 ± 0.1	$C_L = 15 pF, R_L = 2k\Omega$	1.0	13.4		Fig. 3
		1.2			33.5		Fig. 4
t _{OSHL} , t _{OSLH}	Output to Output	3.3 ± 0.3	$C_L = 30 pF, R_L = 500 \Omega$		0.5	ns	
	Skew ⁽⁵⁾	2.5 ± 0.2			0.5		
		1.8 ± 0.15			0.75		
		1.5 ± 0.1	$C_L = 15 pF, R_L = 2k\Omega$		1.5		
		1.2			1.5		

Note:

4. For $C_L = 50 pF$, add approximately 300ps to the AC Maximum specification.

5. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

Dynamic Switching Characteristics

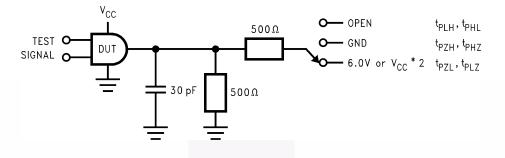
				$T_A = 25^{\circ}C$	
Symbol	Parameter	V _{CC} (V)	Conditions	Typical	Unit
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	1.8	$C_L = 30 pF, V_{IH} = V_{CC},$	0.25	V
		2.5	$V_{IL} = 0V$	0.6	
		3.3		0.8	
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	1.8	$C_L = 30 pF, V_{IH} = V_{CC},$	-0.25	V
		2.5	$V_{IL} = 0V$	-0.6	
		3.3		-0.8	

Capacitance

			$T_A = +25^{\circ}C$	
Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{I} = 0V \text{ or } V_{CC}, V_{CC} = 1.8V, 2.5V \text{ or } 3.3V$	6.0	pF
C _{OUT}	Output Capacitance	V_{I} = 0V or $V_{\text{CC}}, V_{\text{CC}}$ = 1.8V, 2.5V or 3.3V	7.0	pF
C _{PD}	Power Dissipation Capacitance	$V_I = 0V$ or V_{CC} , f = 10MHz, $V_{CC} = 1.8V$, 2.5V or 3.3V	20.0	pF

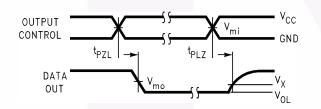


AC Loading and Waveforms (V_{CC} 3.3V \pm 0.3V to 1.8V \pm 0.15V)



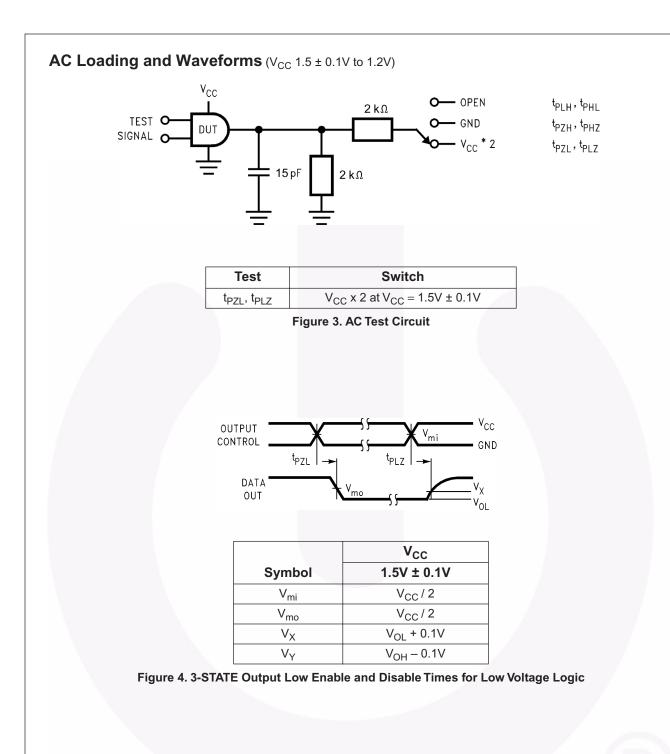
Test	Switch
t _{PZL} , t _{PLZ}	$6V \text{ at } V_{CC} = 3.3 \pm 0.3V;$
	$V_{CC} \times 2$ at $V_{CC} = 2.5V \pm 0.2V$; 1.8V

Figure 1. AC Test Circuit



	V _{cc}					
Symbol	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V			
V _{mi}	1.5V	V _{CC} / 2	V _{CC} / 2			
V _{mo}	1.5V	V _{CC} / 2	V _{CC} / 2			
V _x	V _{OL} + 0.3V	V _{OL} + 0.15V	V _{OL} + 0.15V			

Figure 2. Waveform for Open Drain, Inverting and Non-inverting Functions

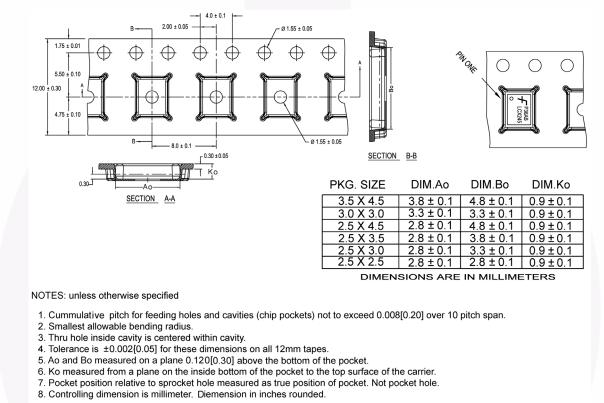


Tape and Reel Specification

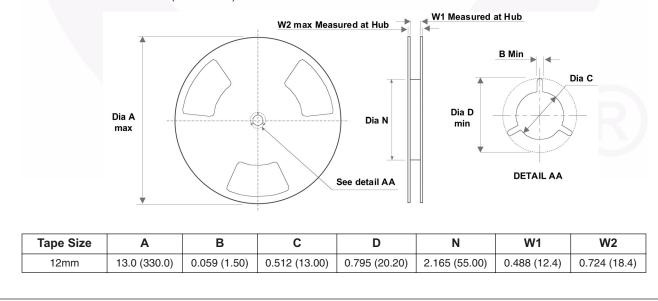
Tape Format for DQFN

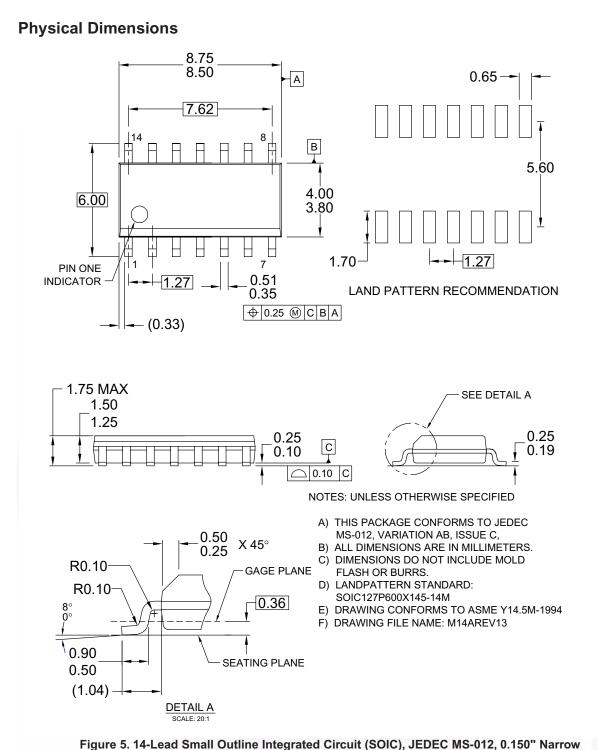
Package Designator	Tape Section	Number of Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (Typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Тур.)	Empty	Sealed

Tape Dimensions inches (millimeters)



Reel Dimensions inches (millimeters)





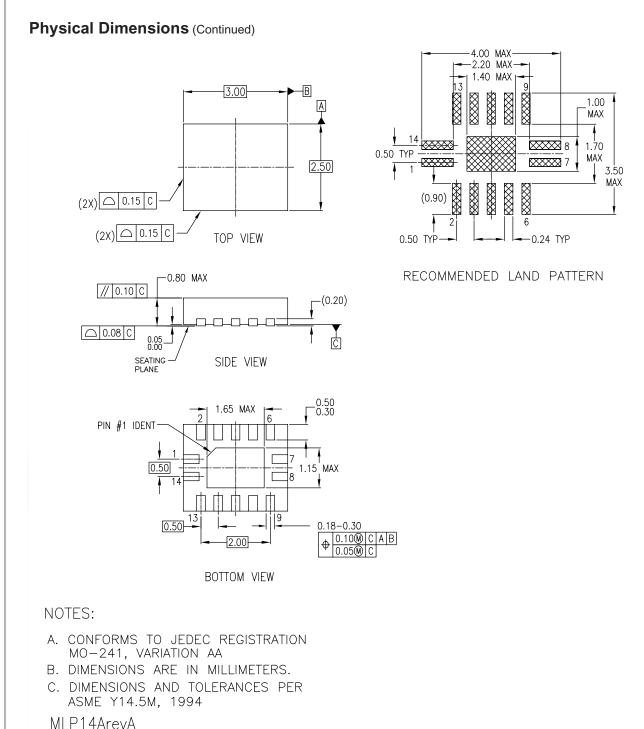
rigure 3. 14-Lead Sman Outline Integrated Circuit (SOIC), SEDEC MS-012, 0.150 Nariow

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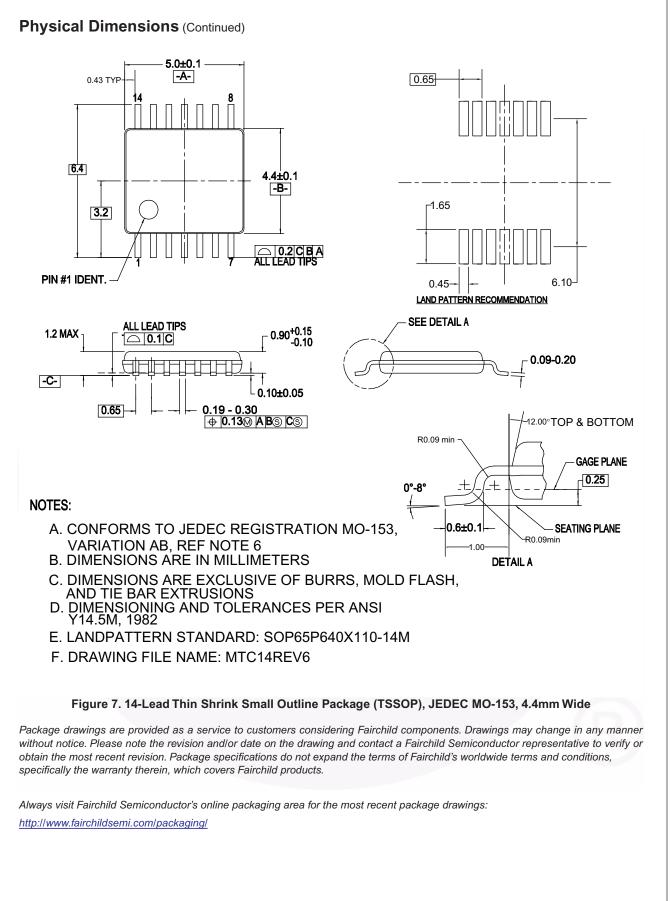
Figure 6. 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm

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